

View Online at https://aerobasegroup.com/nsn/5910-01-151-2769

Body Style:	
Chip type	
Reliability Indicator:	
Established	
Reliability Failure Rate Lo	evel In Percent:
1.0000	
Terminal Length:	
0.015 inches	
Body Length:	
0.110 inches	
Body Width:	
0.110 inches	
Body Height:	
Between 0.058 inches and	0.102 inches
Center To Center Distand	ce Between Terminals Parallel To Width:
0.015 inches	
Schematic Diagram Desig	gnator:
No common or grounded e	ectrode (s)
Capacitance Value Per Se	ection:
43.000 picofarads single se	ection
Nonderated Operating Te	emp:
Between -55.0 degrees cel	lsius and 125.0 degrees celsius
Fempurature Coefficient	Of Capacitance Per Section In Ppm Per Deg Celsius:
90.0 single section	
Nonderated Continuous	Voltage Rating And Type Per Section:
500.0 dc single section	
Tolerance Of Tempuratur	re Coefficient Per Section In Ppm Per Deg Celsius:
-20.0/+20.0 single section	
Tolerance Range Per Sec	tion:
-5.00/+5.00 percent single	section
Case Material:	
Ceramic or glass	
Insulation Resistance At	Reference Temp:
1000000.0 megohms	
Dissipation Factor At Ref	ference Tempurature In Percent:
0.0500	
Test Data Document:	
81349-mil-c-55681 specific	cation (includes engineering type bulletins, brochures, etc., that reflect specification type data in specification
format; excludes commerc	cial catalogs, industry directories, and similar trade publications, reflecting general type data on certain
environmental and perform	nance requirements and test conditions that are shown as "typical", "average", "", etc.).
Terminal Type And Quan	tity:
2 bonding pad	

Specification Data:

81349-mil-c-55681/4 government specification



Shelf Life:

N/a

Unit Of Measure:

Demilitarization:

No

Fiig:

A010b0